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Recent Developments in Magnetic Materials and Devices

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Message from the Guest Editors

This Special Issue aims to collect high-quality review papers from the fields of magnetic materials and devices. We encourage researchers from various fields within the journal's scope to contribute papers highlighting the latest developments through theoretical analysis, numerical simulations, and experiments in their research field, or to invite relevant experts and colleagues to do so. Topics of interest for this Special Issue include but are not limited to:

- Soft magnetic materials and applications;
- Magnetic amorphous and high entropy alloy;
- Functional magnetic materials;
- Magnetoelectric functional materials and devices;
- Multiferroic materials and devices;
- Permanent magnetic materials and their applications;
- Magnetic nanomaterials and biomagnetism.



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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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